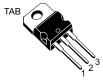
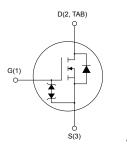


## N-channel 600 V, 0.230 Ω typ., 13 A MDmesh™ M2 EP Power MOSFET in a TO-220 package







#### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>
STB20N60M2-EP	600 V	0.278 Ω	13 A

- · Extremely low gate charge
- Excellent output capacitance (C<sub>OSS</sub>) profile
- · Very low turn-off switching losses
- 100% avalanche tested
- Zener-protected

### **Applications**

- Switching applications
- Tailored for very high frequency converters (f > 150 kHz)

#### **Description**

This device is an N-channel Power MOSFET developed using MDmesh™ M2 enhanced performance (EP) technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance, optimized switching characteristics with very low turn-off switching losses, rendering it suitable for the most demanding very high frequency converters.

Product status link
STP20N60M2-EP

Product summary				
Order code STP20N60M2-E				
Marking	20N60M2EP			
Package	TO-220			
Packing	Tube			



# 1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>GS</sub>	Gate-source voltage	±25	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	13	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	8	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	52	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	110	W
dv/dt <sup>(2)</sup>	Peak diode recovery voltage slope	15	V/ns
dv/dt <sup>(3)</sup>	MOSFET dv/dt ruggedness	50	V/ns
T <sub>J</sub>	Operating junction temperature range	- 55 to 150	°C
T <sub>stg</sub>	Storage temperature range	- 55 to 150	

- 1. Pulse width limited by safe operating area.
- 2.  $I_{SD} \le 13$  A,  $di/dt \le 400$  A/ $\mu s$ ;  $V_{DS peak} < V_{(BR)DSS}$ ,  $V_{DD} = 400$  V.
- 3.  $V_{DS} \le 480 \text{ V}$

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	1.14	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	62.5	°C/W

**Table 3. Avalanche characteristics** 

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by $T_{jmax}$ )	2.7	А
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$ ; $V_{DD} = 50$ V)	138	mJ

DS11505 - Rev 3 page 2/14



## 2 Electrical characteristics

 $T_C$  = 25 °C unless otherwise specified

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA	600			V
lass	Zero gate voltage	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 600 V			1	μA
I <sub>DSS</sub>	Drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}, T_{C} = 125 ^{\circ}\text{C}^{(1)}$			100	μA
I <sub>GSS</sub>	Gate-body leakage current	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±25 V			±10	μA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.25	4	4.75	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6.5 A		0.230	0.278	Ω

<sup>1.</sup> Defined by design, not subject to production test.

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	787	-	
C <sub>oss</sub>	Output capacitance	V <sub>DS</sub> = 100 V, f = 1 MHz, V <sub>GS</sub> = 0 V	-	50	-	pF
C <sub>rss</sub>	Reverse transfer capacitance		-	1.2	-	
Coss eq. (1)	Equivalent output capacitance	V <sub>DS</sub> = 0 to 480 V, V <sub>GS</sub> = 0 V	-	89	-	pF
R <sub>G</sub>	Intrinsic gate resistance	f = 1 MHz, I <sub>D</sub> = 0 A	-	5.9	-	Ω
Qg	Total gate charge	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 13 A, V <sub>GS</sub> = 0 to 10 V	-	22	-	
Q <sub>gs</sub>	Gate-source charge	(see Figure 15. Test circuit for gate	-	3.5	-	nC
Q <sub>gd</sub>	Gate-drain charge	charge behavior)	-	10.5	-	

<sup>1.</sup>  $C_{oss\ eq.}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ 

Table 6. Switching energy

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E <sub>off</sub>	Turn-off energy (from 90% V <sub>GS</sub>	$V_{DD}$ = 400 V, $I_{D}$ = 2 A, $R_{G}$ = 4.7 $\Omega$ , $V_{GS}$ = 10 V	-	7.2	-	μJ
	to 0% I <sub>D</sub> )	$V_{DD}$ = 400 V, $I_{D}$ = 5 A, $R_{G}$ = 4.7 $\Omega$ , $V_{GS}$ = 10 V	-	20.4	-	μJ

DS11505 - Rev 3 page 3/14



### Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD}$ = 300 V, $I_{D}$ = 6.5 A, $R_{G}$ = 4.7 $\Omega$ , $V_{GS}$ = 10 V (see Figure 14. Test circuit for resistive load switching times and Figure 19. Switching time waveform)	-	10.5	-	ns
t <sub>r</sub>	Rise time		-	5.2	-	ns
t <sub>d(off)</sub>	Turn-off delay time		-	41	-	ns
t <sub>f</sub>	Fall time		-	8	-	ns

#### Table 8. Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		13	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		52	Α
V <sub>SD</sub> (2)	Forward on voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 13 A	-		1.6	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 13 A, di/dt = 100 A/μs, V <sub>DD</sub> = 60 V	-	230		ns
Q <sub>rr</sub>	Reverse recovery charge	(see Figure 16. Test circuit for inductive load switching and diode recovery	-	2.3		μC
I <sub>RRM</sub>	Reverse recovery current	times )	-	20		Α
t <sub>rr</sub>	Reverse recovery time	$I_{SD}$ = 13 A, di/dt = 100 A/ $\mu$ s, $V_{DD}$ = 60 V,	-	287		ns
Q <sub>rr</sub>	Reverse recovery charge	T <sub>j</sub> = 150 °C (see Figure 16. Test circuit for inductive load switching and diode	-	2.9		μC
I <sub>RRM</sub>	Reverse recovery current	recovery times)	-	20.2		Α

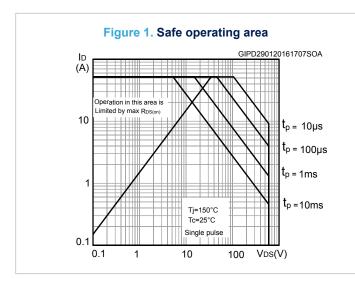
<sup>1.</sup> Pulse width is limited by safe operating area

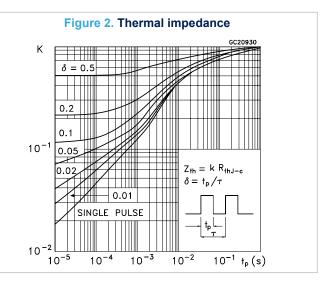
DS11505 - Rev 3 page 4/14

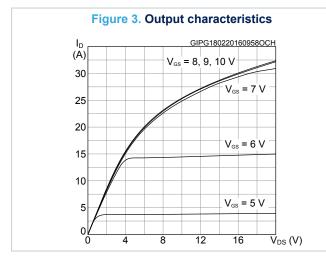
<sup>2.</sup> Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%

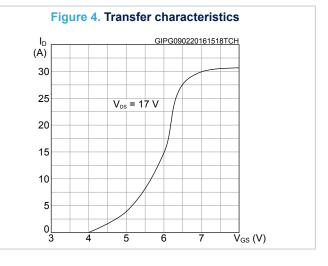


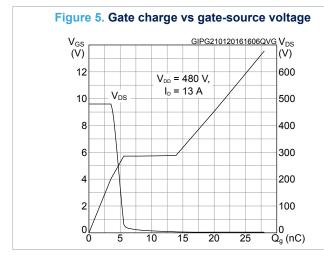
### 2.1 Electrical characteristics (curves)

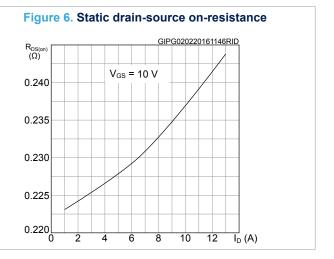












DS11505 - Rev 3 page 5/14



Figure 7. Capacitance variations

C GIPG210120161637CVR

1000

Coss

Coss

Coss

1000

Coss

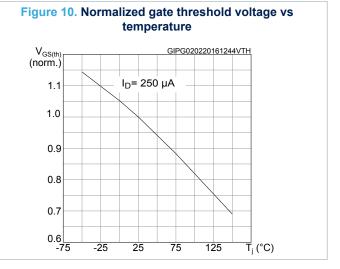
Coss

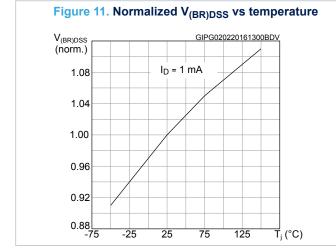
1000

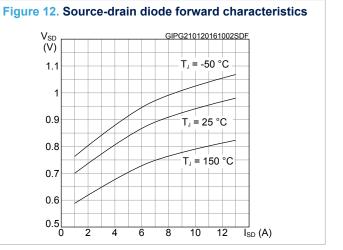
Coss

Cos

E<sub>OSS</sub> GIPG210120161026EOS (μJ) 6 5 4 4 3 2 2 1 0 0 100 200 300 400 500 600 V<sub>DS</sub> (V)

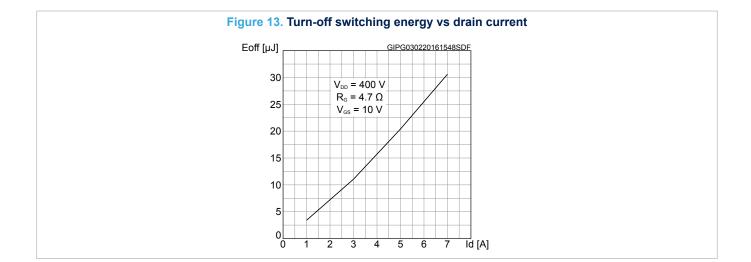






DS11505 - Rev 3 page 6/14







### 3 Test circuits

Figure 14. Test circuit for resistive load switching times

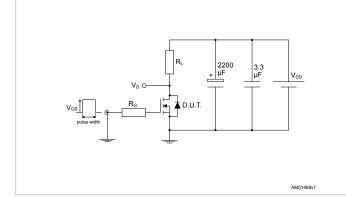


Figure 15. Test circuit for gate charge behavior

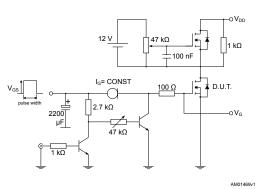


Figure 16. Test circuit for inductive load switching and diode recovery times

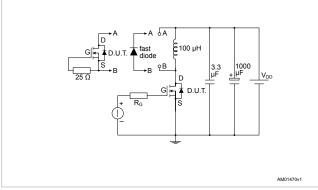


Figure 17. Unclamped inductive load test circuit

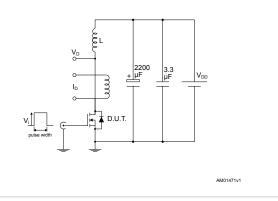


Figure 18. Unclamped inductive waveform

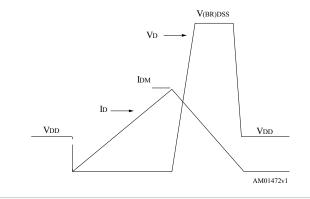
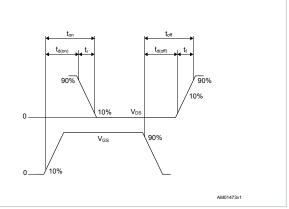


Figure 19. Switching time waveform



DS11505 - Rev 3 page 8/14



# 4 Package information

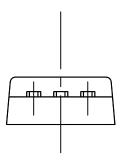
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

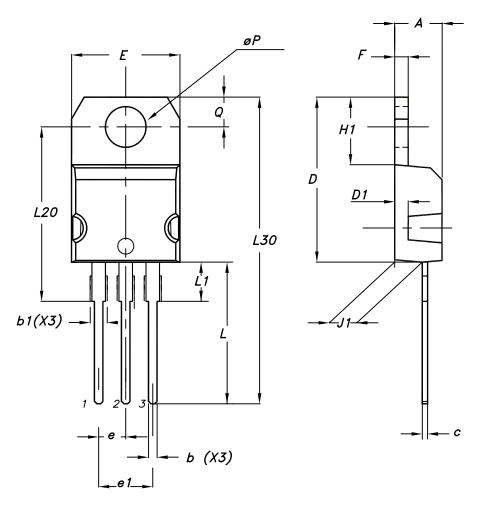
DS11505 - Rev 3 page 9/14



## 4.1 TO-220 package information

Figure 20. TO-220 type A package outline





0015988\_typeA\_Rev\_21



Table 9. TO-220 type A package mechanical data

Dim.	mm					
Dim.	Min.	Тур.	Max.			
А	4.40		4.60			
b	0.61		0.88			
b1	1.14		1.55			
С	0.48		0.70			
D	15.25		15.75			
D1		1.27				
E	10.00		10.40			
е	2.40		2.70			
e1	4.95		5.15			
F	1.23		1.32			
H1	6.20		6.60			
J1	2.40		2.72			
L	13.00		14.00			
L1	3.50		3.93			
L20		16.40				
L30		28.90				
øΡ	3.75		3.85			
Q	2.65		2.95			

DS11505 - Rev 3 page 11/14



# **Revision history**

Table 10. Document revision history

Date	Revision	Changes
26-Feb-2016	1	First release.
	2	The part numbers STI20N60M2-EP and STW20N60M2-EP have been moved in a separate datasheet. The document has been updated accordingly.
16-Mar-2018		Removed maturity status indication from cover page. The document status is production data.
		Updated Section 1 Electrical ratings, Section 2 Electrical characteristics and Section 2.1 Electricalcharacteristics (curves).
		Minor text changes.
		Modified Table 1. Absolute maximum ratings and Table 8. Source-drain diode.
04-Jun-2018	3	Modified Figure 1. Safe operating area.
		Minor text changes.

DS11505 - Rev 3 page 12/14







## **Contents**

1	Electrical ratings				
2		Electrical characteristics			
	2.1	Electrical characteristics (curves)	5		
3	Test	circuits	8		
4	Package information				
	4.1	TO-220 package information	9		
Rev	vision	history	12		



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DS11505 - Rev 3 page 14/14